* Notes:

1) R12 for test purposes only
2) tested w/ battery YUASA NPH 5-12 = 12V / 5Ah / AGM

You should completely validate and test your design implementation to confirm the system functionality for your application.

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- **VIN 9V to 36V**
- **Fsw 300kHz**
- **Vsense 2.49V**
- **13.8 @ 1.5Amax**
- **Vb 700mV**
- **Voltage loop Fco 200Hz**
- **Current sense is injected here via diode ORing**

**Variants name not interpreted**

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